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PATENT

Docket No. JCLA7259

Date: 2 - 15 - 2002

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ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventors: Sheng-Tsung Liu; Kang-Wei Ma

For: PACKAGING STRUCTURE INTEGRATING PASSIVE DEVICES

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- Specification 10 pages.
- Sheets of drawings
 Sheets of dra
- Recordation Form Cover sheet with 2 pages assignment.
- A certified copy of Taiwan Patent Application No. ___ dated __.
- SIGNED declaration and power of attorney.
- Return Prepaid postcard.

CLAIMS AS FILED							
FOR	NUMB	ER FII	ED N	NUMBEI	REXTRA	RATE	FEE
Basic Fee						\$740.00	\$740.00
Total Claims	15		20 =	0	×	\$18.00	\$0.00
Independent Claims	4		3 =	1	×	\$84.00	\$84.00
If application contains any	multiple depend	ent clair	m(s), the	en add	-AH.*	\$280.00	\$0.00
- Tr	TOTAL			*			\$824.00

A check in the amount of \$824.00 cover the filing fee is enclosed.

A check in the amount of \$40.00 to cover the assignment recording fee.

A duplicate copy of this sheet is enclosed.

Jiawei Huang

Registration No. 43,330

J.C. PATENTS, INC.

4 VENTURE, SUITE 250 IRVINE, CALIFORNIA 92618 (949) 660-0761

FAX: (949) 660-0809

Assistant Commissioner for Patents Washington, D.C. 20231

CERTIFICATE OF MAILING BY "EXPRESS MAIL"

Docket No.	: JCLA7259
Applicant(s)	: Sheng-Tsung Liu; Kang-Wei Ma
For	: PACKAGING STRUCTURE INTEGRATING PASSIVE DEVICES
"Express Mail"	: EV 016847655 US
Mailing Label No.	
Date of Deposit	: Feb. 15, 2002

I hereby certify that the accompanying

Transmittal in Duplicate; Specification 10 pages, 3 sheets of drawings; **SIGNED**Declaration and Power of Attorney 2 pages; Recordation Form Cover Sheet and Assignment 3 pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

M. Chanf Michelle Chang